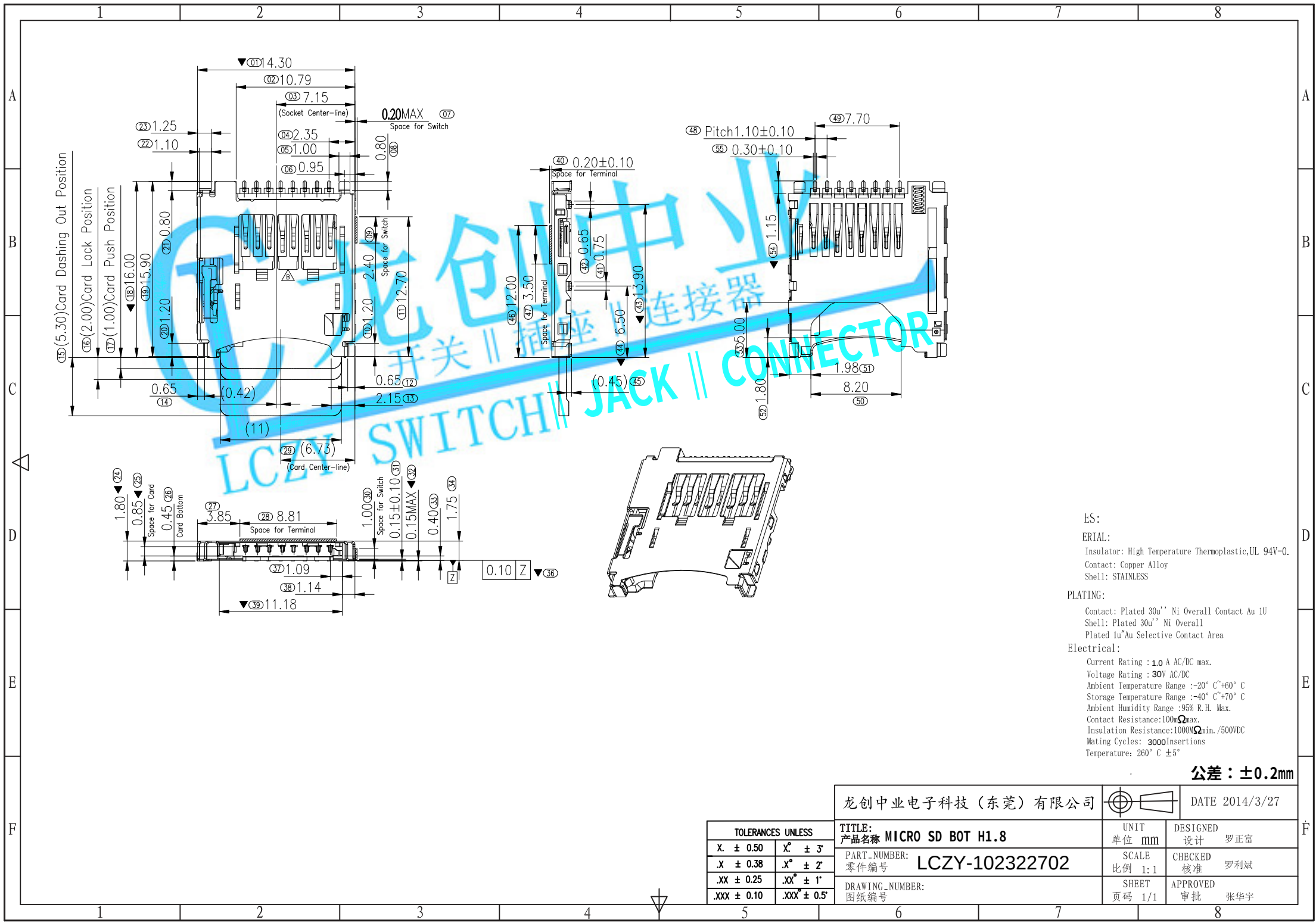




ES:
ERIAL:
Insulator: High Temperature Thermoplastic,UL 94V-0.
Contact: Copper Alloy
Shell: STAINLESS

PLATING:
Contact: Plated 30u'' Ni Overall Contact Au 1U
Shell: Plated 30u'' Ni Overall
Plated 1u''Au Selective Contact Area

Electrical:
Current Rating :1.0 A AC/DC max.
Voltage Rating :30V AC/DC
Ambient Temperature Range :-20° C~+60° C
Storage Temperature Range :-40° C~+70° C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100mΩmax.
Insulation Resistance:1000MΩmin./500VDC
Mating Cycles: 3000Insertions
Temperature: 260° C ±5°

公差：±0.2mm

龙创中业电子科技（东莞）有限公司			DATE 2014/3/27
TITLE: 产品名称 MICRO SD BOT H1.8		UNIT 单位 mm	DESIGNED 设计 罗正富
PART NUMBER: 零件编号 LCZY-102322702		SCALE 比例 1:1	CHECKED 核准 罗利斌
DRAWING NUMBER: 图纸编号		SHEET 页码 1/1	APPROVED 审批 张华宇

TOLERANCES UNLESS	
X. ± 0.50	X° ± 3°
.X ± 0.38	.X° ± 2°
.XX ± 0.25	.XX° ± 1°
.XXX ± 0.10	.XXX° ± 0.5°